1Mx32 SRAM 3.3V MODULE *PRELIMINARY**

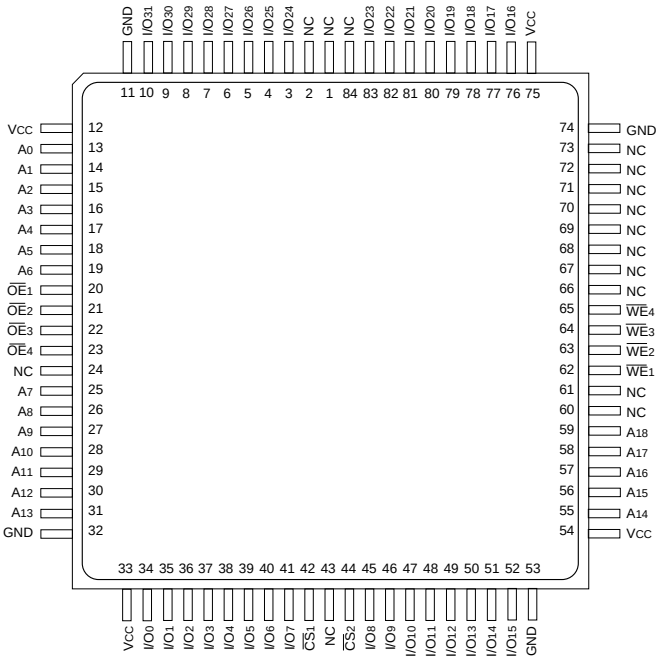
FEATURES

- Access Times of 17, 20, 25ns
- 84 lead, 28mm CQFP, (Package 511)
- Organized as two banks of 512Kx32, User Configurable as 2Mx16 or 4Mx8
- Commercial and Industrial Temperature Ranges
- TTL Compatible Inputs and Outputs
- 3.3 Volt Power Supply
- Low Power CMOS
- Built-in Decoupling Caps and Multiple Ground Pins for Low Noise Operation
- Weight
  WS1M32V-XG3X - 20 grams typical

* *This data sheet describes a product under development, not fully characterized, and is subject to change without notice.*

PIN CONFIGURATION FOR WS1M32V-XG3X

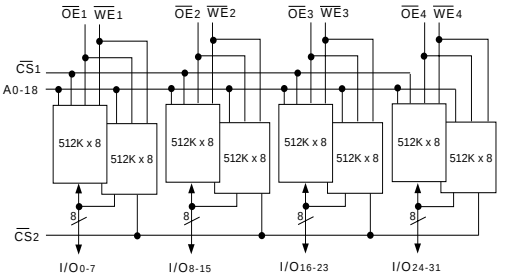
TOP VIEW



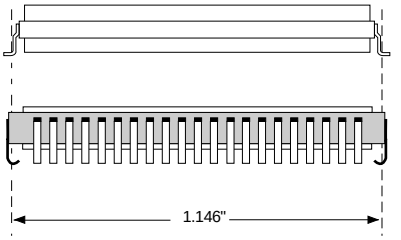
PIN DESCRIPTION

I/O_{0-31}	Data Inputs/Outputs
A_{0-18}	Address Inputs
$\overline{WE}_{1-4}$	Write Enables
$\overline{CS}_{1-2}$	Chip Selects
$\overline{OE}_{1-4}$	Output Enables
V_{CC}	+3.3V Power Supply
GND	Ground
NC	Not Connected

BLOCK DIAGRAM



NOTE: $\overline{CS}_1$ & $\overline{CS}_2$ are used as bank select



The WEDC 84 lead G3 CQFP fills the same fit and function as the JEDEC 84 lead CQFJ or 84 PLCC. But the G3 has the TCE and lead inspection advantage of the CQFP form.

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
Operating Temperature	T_A	-40	+85	°C
Storage Temperature	T_{STG}	-65	+150	°C
Signal Voltage Relative to GND	V_G	-0.5	4.6	V
Junction Temperature	T_J		150	°C
Supply Voltage	V_{CC}	-0.5	4.6	V

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min	Max	Unit
Supply Voltage	V_{CC}	3.0	3.6	V
Input High Voltage	V_{IH}	2.2	V_{CC} + 0.3	V
Input Low Voltage	V_{IL}	-0.3	+0.8	V

TRUTH TABLE

$\overline{CS}$	$\overline{OE}$	$\overline{WE}$	Mode	Data I/O	Power
H	X	X	Standby	High Z	Standby
L	L	H	Read	Data Out	Active
L	X	L	Write	Data In	Active
L	H	H	Out Disable	High Z	Active

CAPACITANCE

(T_A = +25°C)

Parameter	Symbol	Conditions	Max	Unit
$\overline{OE}_{1\text{-}4}$ capacitance	C_{OE}	V_{IN} = 0 V, f = 1.0 MHz	20	pF
$\overline{WE}_{1\text{-}4}$ capacitance	C_{WE}	V_{IN} = 0 V, f = 1.0 MHz	20	pF
$\overline{CS}_{1\text{-}2}$ capacitance	C_{CS}	V_{IN} = 0 V, f = 1.0 MHz	50	pF
Data I/O capacitance	$C_{I/O}$	$V_{I/O}$ = 0 V, f = 1.0 MHz	20	pF
Address input capacitance	C_{AD}	V_{IN} = 0 V, f = 1.0 MHz	70	pF

This parameter is guaranteed by design but not tested.

DC CHARACTERISTICS

(V_{CC} = 3.3V ±0.3V, T_A = -40°C to +85°C)

Parameter	Sym	Conditions	Min	Max	Units
Input Leakage Current	I_{LI}	V_{IN} = GND to V_{CC}		10	µA
Output Leakage Current	I_{LO}	$\overline{CS}$ = V_{IH}, $\overline{OE}$ = V_{IH}, V_{OUT} = GND to V_{CC}		10	µA
Operating Supply Current (x 32 Mode)	I_{CC} x 32	$\overline{CS}$ = V_{IL}, $\overline{OE}$ = V_{IH}, f = 5MHz, V_{CC} = 3.6V		440	mA
Standby Current	I_{SB}	$\overline{CS}$ = V_{IH}, $\overline{OE}$ = V_{IH}, f = 5MHz, V_{CC} = 3.6V		400	mA
Output Low Voltage	V_{OL}	I_{OL} = 4.0mA		0.4	V
Output High Voltage	V_{OH}	I_{OH} = -4.0mA	2.4		V

NOTE: DC test conditions: V_{IH} = V_{CC} -0.3V, V_{IL} = 0.3V

AC CHARACTERISTICS

(V_{CC} = 3.3V, GND = 0V, T_A = -40°C to +85°C)

Parameter	Symbol	-17		-20		-25		Units
Read Cycle		**Min**	**Max**	**Min**	**Max**	**Min**	**Max**	
Read Cycle Time	t_{RC}	17		20		25		ns
Address Access Time	t_{AA}		17		20		25	ns
Output Hold from Address Change	t_{OH}	0		0		0		ns
Chip Select Access Time	t_{ACS}		17		20		25	ns
Output Enable to Output Valid	t_{OE}		10		10		12	ns
Chip Select to Output in Low Z	t_{CLZ}[1]	1		1		1		ns
Output Enable to Output in Low Z	t_{OLZ}[1]	0		0		0		ns
Chip Disable to Output in High Z	t_{CHZ}[1]		12		12		12	ns
Output Disable to Output in High Z	t_{OHZ}[1]		12		12		12	ns

1. This parameter is guaranteed by design but not tested.

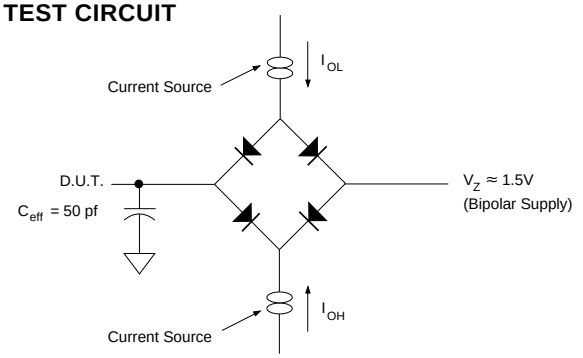
AC CHARACTERISTICS

(V_{CC} = 3.3V, GND = 0V, T_A = -40°C to +85°C)

Parameter	Symbol	-17		-20		-25		Units
Write Cycle		**Min**	**Max**	**Min**	**Max**	**Min**	**Max**	
Write Cycle Time	t_{WC}	17		20		25		ns
Chip Select to End of Write	t_{CW}	15		15		17		ns
Address Valid to End of Write	t_{AW}	15		15		17		ns
Data Valid to End of Write	t_{DW}	11		12		13		ns
Write Pulse Width	t_{WP}	15		15		17		ns
Address Setup Time	t_{AS}	2		2		2		ns
Address Hold Time	t_{AH}	0		0		0		ns
Output Active from End of Write	t_{OW}[1]	2		3		4		ns
Write Enable to Output in High Z	t_{WHZ}[1]		9		11		13	ns
Data Hold Time	t_{DH}	0		0		0		ns

1. This parameter is guaranteed by design but not tested.

AC TEST CIRCUIT

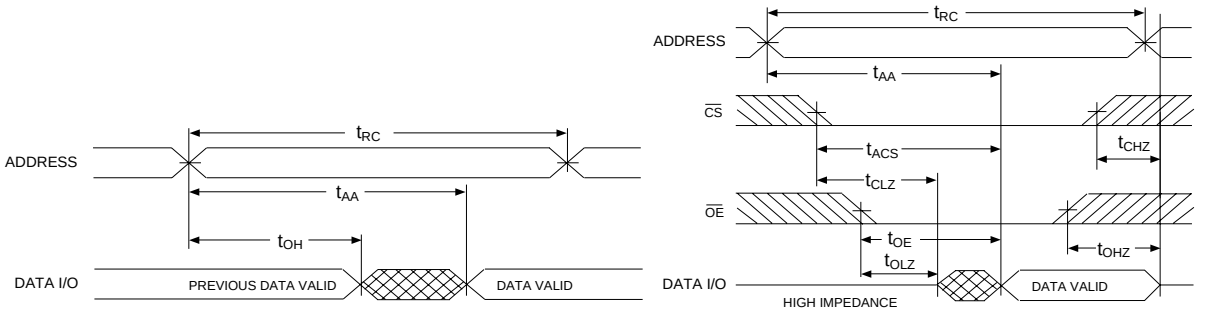


AC TEST CONDITIONS

Parameter	Typ	Unit
Input Pulse Levels	V_{IL} = 0, V_{IH} = 2.5	V
Input Rise and Fall	5	ns
Input and Output Reference Level	1.5	V
Output Timing Reference Level	1.5	V

NOTES:
V_Z is programmable from -2V to +7V.
I_{OL} & I_{OH} programmable from 0 to 16mA.
Tester Impedance Z_0 = 75 Ω.
V_Z is typically the midpoint of V_{OH} and V_{OL}.
I_{OL} & I_{OH} are adjusted to simulate a typical resistive load circuit.
ATE tester includes jig capacitance.

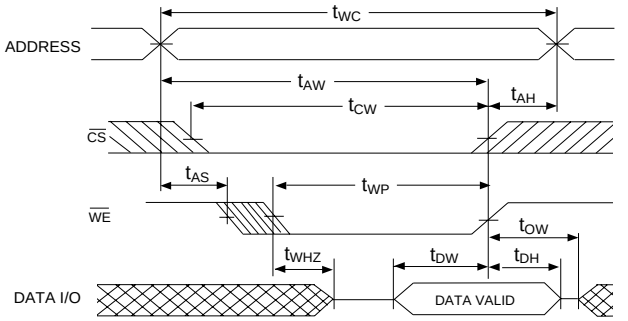
TIMING WAVEFORM - READ CYCLE



READ CYCLE 1 ($\overline{CS}$ = $\overline{OE}$ = V_{IL}, $\overline{WE}$ = V_{IH})

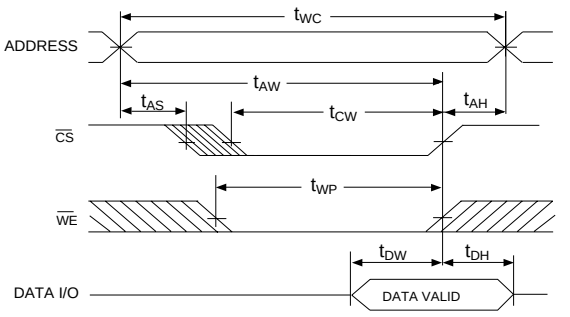
READ CYCLE 2 ($\overline{WE}$ = V_{IH})

WRITE CYCLE - $\overline{WE}$ CONTROLLED



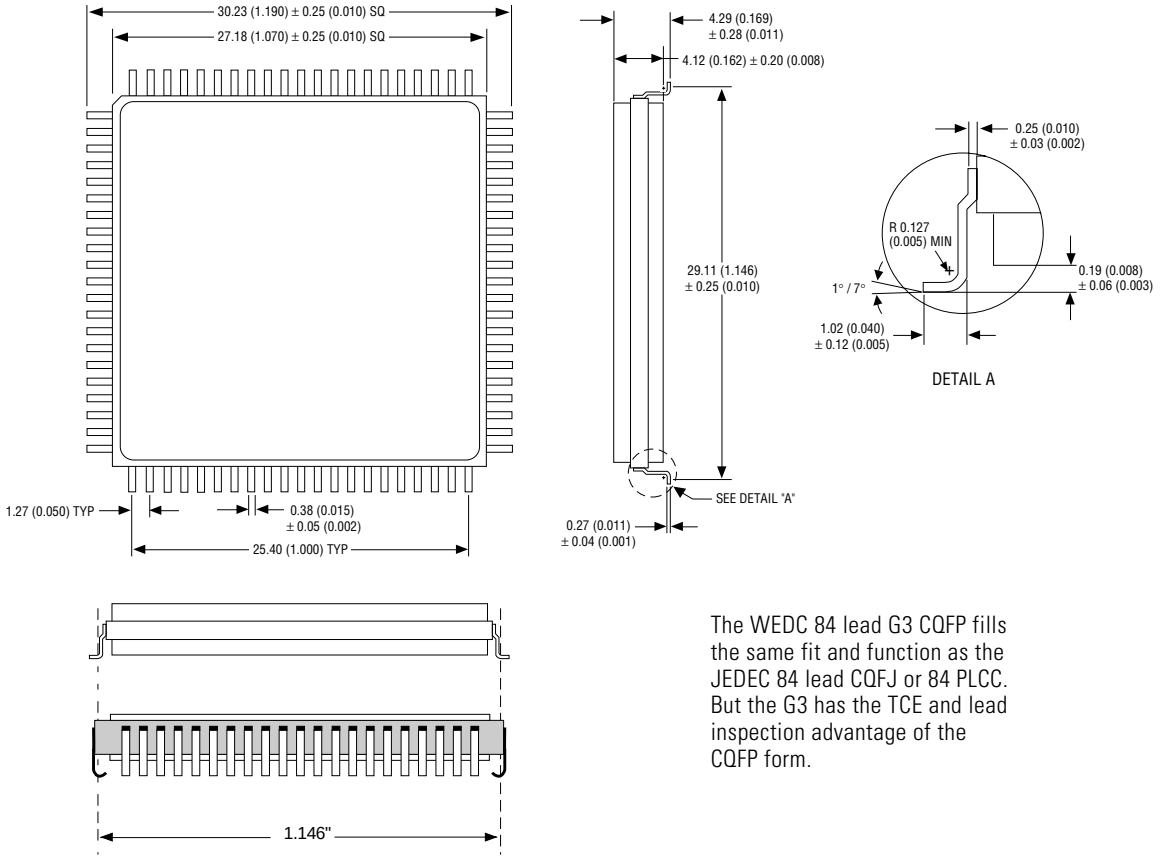
WRITE CYCLE 1, $\overline{WE}$ CONTROLLED

WRITE CYCLE - $\overline{CS}$ CONTROLLED



WRITE CYCLE 2, $\overline{CS}$ CONTROLLED

PACKAGE 511: 84 LEAD, CERAMIC QUAD FLAT PACK (G3)



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ALL LINEAR DIMENSIONS ARE MILLIMETERS AND PARENTHETICALLY IN INCHES

ORDERING INFORMATION